IS65LV256AL IS62LV256AL





FEBRUARY 2020

FEATURES

- High-speed access time: 20, 45 ns
- · Automatic power-down when chip is deselected
- · CMOS low power operation
 - 17 µW (typical) CMOS standby
 - 50 mW (typical) operating
- TTL compatible interface levels
- Single 3.3V power supply
- Fully static operation: no clock or refresh required
- · Three-state outputs
- · Industrial and Automotive temperatures available
- Lead-free available

DESCRIPTION

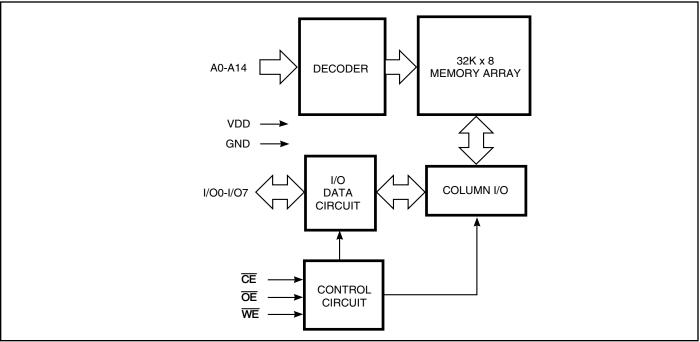
The *ISSI* IS62/65LV256AL is a very high-speed, low power, 32,768-word by 8-bit static RAM. It is fabricated using *ISSI*'s high-performance CMOS technology. This highly reliable process coupled with innovative circuit design techniques, yields access times as fast as 15 ns maximum.

When \overline{CE} is HIGH (deselected), the device assumes a standby mode at which the power dissipation is reduced to 150 μ W (typical) with CMOS input levels.

Easy memory expansion is provided by using an active LOW Chip Enable (\overline{CE}). The active LOW Write Enable (\overline{WE}) controls both writing and reading of the memory.

The IS62/65LV256AL is available in the JEDEC standard 28-pin SOJ, 28-pin SOP, and the 28-pin TSOP (Type I) package.





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b.) the user assume all such risks; and

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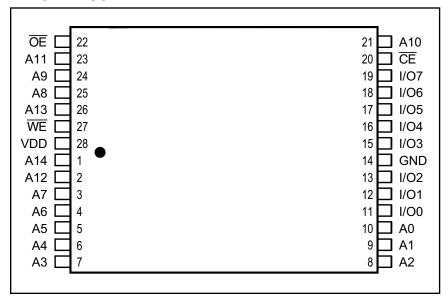
IS65LV256AL IS62LV256AL



PIN CONFIGURATION 28-Pin SOJ/ 28-pin SOP

r		
L	$-\overline{\mathbf{v}}$	- L
A14 🗌	1	28 🗌 VDD
A12 🗌	2	27 🛛 WE
A7 🗌	3	26 🗌 A13
A6 🗌	4	25 🗌 A8
A5 🗌	5	24 🗌 A9
A4 🗌	6	23 🗋 A11
A3 🗌	7	22 🗍 💽
A2 🗌	8	21 🗌 A10
A1 [9	20 🗌 🔁
A0 [10	19 🛛 I/O7
I/O0 [11	18 🗌 I/O6
I/O1 [12	17 🗍 I/O5
I/O2 [13	16 🗍 I/O4
GND	14	15 🗍 I/O3

PIN CONFIGURATION 28-Pin TSOP



PIN DESCRIPTIONS

A0-A14	Address Inputs
CE	Chip Enable Input
ŌĒ	Output Enable Input
WE	Write Enable Input
I/O0-I/O	7 Input/Output
Vdd	Power
GND	Ground

TRUTH TABLE

Mode	WE	CE	ŌĒ	I/O Operation	VDD Current
Not Selected (Power-down)	Х	Н	Х	High-Z	ISB1, ISB2
Output Disabled	Н	L	Н	High-Z	lcc1, lcc2
Read	Н	L	L	Dout	lcc1, lcc2
Write	L	L	Х	Din	lcc1, lcc2

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

Symbol	Parameter	Value	Unit
VTERM	Terminal Voltage with Respect to GND	-0.5 to +4.6	V
TBIAS	Temperature Under Bias	-55 to +125	°C
Tstg	Storage Temperature	-65 to +150	°C
P⊤	Power Dissipation	0.5	W
Ιουτ	DC Output Current (LOW)	20	mA

Note:

 Stress greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

OPERATING RANGE

Part No.	Range	Ambient Temperature	Vdd	
IS62LV256AL	Commercial	0°C to +70°C	3.3V ± 10%	
IS62LV256AL	Industrial	–40°C to +85°C	3.3V ± 10%	
IS65LV256AL	Automotive	–40°C to +125°C	3.3V ± 10%	

DC ELECTRICAL CHARACTERISTICS (Over Operating Range)

Symbol	Parameter	Test Conditions		Min.	Max.	Unit
Vон	Output HIGH Voltage	Vdd = Min., Iон = -2.0 mA		2.4	—	V
Vol	Output LOW Voltage	$V_{DD} = Min., IOL = 4.0 mA$	$V_{DD} = Min., I_{OL} = 4.0 mA$		0.4	V
VIH	Input HIGH Voltage			2.2	VDD + 0.3	V
VIL	Input LOW Voltage ⁽¹⁾			-0.3	0.8	V
I LI	Input Leakage	$GND \leq V_{IN} \leq V_{DD}$	Com.	-1	1	μA
			Ind.	-2	2	
			Auto.	-10	10	
Ilo	Output Leakage	$GND \leq VOUT \leq VDD$, Outputs Disabled	Com.	-1	1	μA
			Ind.	-2	2	
			Auto.	-10	10	

Notes:

1. $V_{IL} = -3.0V$ for pulse width less than 10 ns.

2. Not more than one output should be shorted at one time. Duration of the short circuit should not exceed 30 seconds.



POWER SUPPLY CHARACTERISTICS⁽¹⁾ (Over Operating Range)

Symb	ol Parameter	Test Conditions		-20 ns Min. Max.	-45 ns Min. Max.	Unit
Icc1	Vod Operating Supply Current	$V_{DD} = Max., \overline{CE} = V_{IL}$ lout = 0 mA, f = 0	Com. Ind. Auto.	— 4 — 5 — —	— 4 — 5 — 8	mA
Icc2	VDD Dynamic Operating Supply Current	$V_{DD} = Max., \overline{CE} = V_{IL}$ IOUT = 0 mA, f = fMAX	Com. Ind. Auto. typ. ⁽²⁾	— 20 — 25 — — 15	— 10 — 12 — 20 7	mA
ISB1	TTL Standby Current (TTL Inputs)	$\label{eq:VDD} \begin{array}{l} V_{DD} = Max., \\ V_{IN} = V_{IH} \mbox{ or } V_{IL} \\ \hline \overline{CE} \geq V_{IH}, \mbox{ f} = 0 \end{array}$	Com. Ind. Auto.	— 1.5 — 1.8 — —	1.5 1.8 2	mA
ISB2	CMOS Standby Current (CMOS Inputs)	$\label{eq:VDD} \begin{array}{l} \hline V_{DD} = Max., \\ \hline CE \leq V_{DD} - 0.2V, \\ \hline V_{IN} > V_{DD} - 0.2V, \mbox{ or } \\ \hline V_{IN} \leq 0.2V, \mbox{ f} = 0 \end{array}$	Com. Ind. Auto. typ. ⁽²⁾	-15 -20 -2	— 15 — 20 — 50 2	μA

Note:

1. At f = fMAX, address and data inputs are cycling at the maximum frequency, f = 0 means no input lines change. 2. Typical values are measured at V_{DD} = 3.3V, TA = 25°C and not 100% tested.

CAPACITANCE^(1,2)

Symbol	Parameter	Conditions	Max.	Unit
CIN	Input Capacitance	$V_{IN} = 0V$	6	pF
Соит	Output Capacitance	VOUT = 0V	5	pF

Notes:

1. Tested initially and after any design or process changes that may affect these parameters.

2. Test conditions: $T_A = 25^{\circ}C$, f = 1 MHz, $V_{DD} = 3.3V$.

READ CYCLE SWITCHING CHARACTERISTICS⁽¹⁾ (Over Operating Range)

		-20	ns	-45 ns		
Symbol	Parameter	Min.	Max.	Min. Ma	ax. Unit	
trc	Read Cycle Time	20	_	45 –	– ns	
taa	Address Access Time		20	— 4	5 ns	
tона	Output Hold Time	2	—	2 –	– ns	
t ACE	CE Access Time	_	20	— 4	5 ns	
t doe	OE Access Time		10	— 2	5 ns	
tLZOE ⁽²⁾	OE to Low-Z Output	0	—	0 –	– ns	
thzoe ⁽²⁾	OE to High-Z Output		9	0 2	0 ns	
tLZCE ⁽²⁾	CE to Low-Z Output	3	_	3 –	– ns	
tHZCE ⁽²⁾	CE to High-Z Output		9	0 2	0 ns	
t PU ⁽³⁾	CE to Power-Up	0	_	0 –	– ns	
tPD ⁽³⁾	CE to Power-Down	_	18	— 3	0 ns	

Notes:

1. Test conditions assume signal transition times of 3 ns or less, timing reference levels of 1.5V, input pulse levels of 0 to 3.0V and output loading specified in Figure 1.

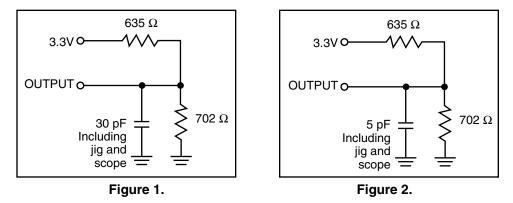
2. Tested with the load in Figure 2. Transition is measured ±500 mV from steady-state voltage. Not 100% tested.

3. Not 100% tested.

AC TEST CONDITIONS

Parameter	Unit
Input Pulse Level	0V to 3.0V
Input Rise and Fall Times	3 ns
Input and Output Timing	1.5V
and Reference Levels	
Output Load	See Figures 1 and 2

AC TEST LOADS

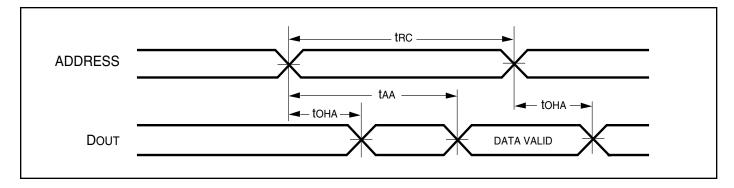


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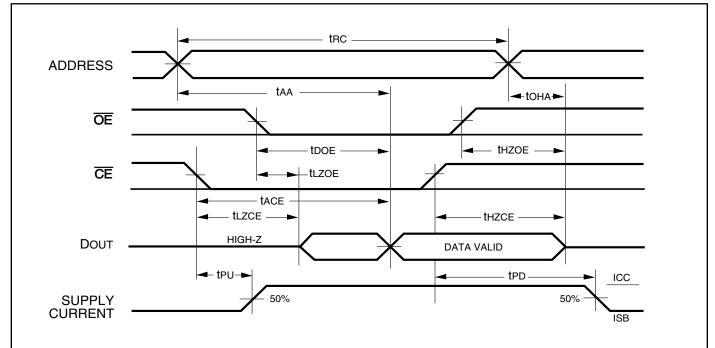


AC WAVEFORMS

READ CYCLE NO. 1^(1,2)



READ CYCLE NO. 2(1,3)



Notes:

- 1. WE is HIGH for a Read Cycle.
- 2. The device is continuously selected. \overline{OE} , $\overline{CE} = V_{IL}$. 3. Address is valid prior to or coincident with \overline{CE} LOW transitions.

WRITE CYCLE SWITCHING CHARACTERISTICS^(1,3) (Over Operating Range)

		-20 I	ns	-45	ns	
Symbol	Parameter	Min.	Max.	Min.	Max.	Unit
twc	Write Cycle Time	20	_	45	_	ns
tsce	CE to Write End	14		35	—	ns
taw	Address Setup Time to Write End	14		25	—	ns
tна	Address Hold from Write End	0		0	_	ns
t SA	Address Setup Time	0		0		ns
tPWE ⁽⁴⁾	WE Pulse Width	14		25		ns
tsp	Data Setup to Write End	13	_	20	—	ns
thd	Data Hold from Write End	0		0		ns
tHZWE ⁽²⁾	WE LOW to High-Z Output	_	8		20	ns
tLZWE ⁽²⁾	WE HIGH to Low-Z Output	0		0		ns

Notes:

1. Test conditions assume signal transition times of 3 ns or less, timing reference levels of 1.5V, input pulse levels of 0 to 3.0V and output loading specified in Figure 1.

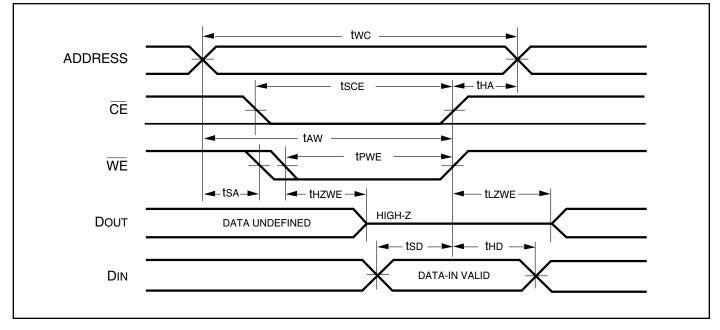
2. Tested with the load in Figure 2. Transition is measured ±500 mV from steady-state voltage. Not 100% tested.

3. The internal write time is defined by the overlap of CE LOW and WE LOW. All signals must be in valid states to initiate a Write, but any one can go inactive to terminate the Write. The Data Input Setup and Hold timing are referenced to the rising or falling edge of the signal that terminates the Write.

4. Tested with OE HIGH.

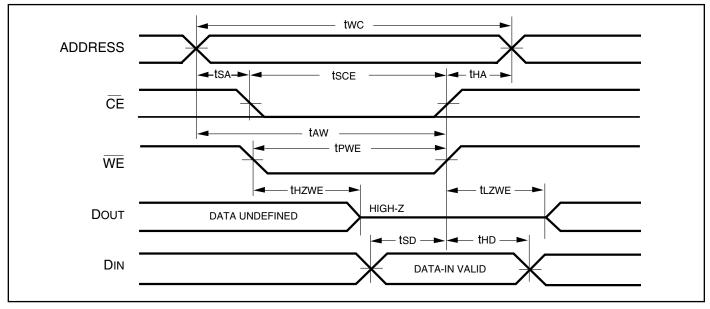
AC WAVEFORMS

WRITE CYCLE NO. 1 (WE Controlled)^(1,2)





WRITE CYCLE NO. 2 (CE Controlled)^(1,2)



Notes:

- 1. The internal write time is defined by the overlap of CE LOW and WE LOW. All signals must be in valid states to initiate a Write, but any one can go inactive to terminate the Write. The Data Input Setup and Hold timing are referenced to the rising or falling edge of the signal that terminates the Write.
- 2. I/O will assume the High-Z state if $\overline{OE} \ge V_{IH}$.



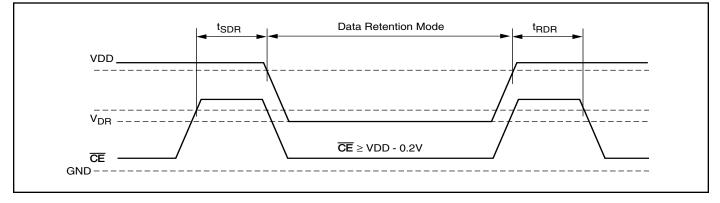
DATA RETENTION SWITCHING CHARACTERISTICS

Symbol	Parameter	Test Condition		Min.	Тур.	Max.	Unit
Vdr	VDD for Data Retention	See Data Retention Waveform		2.0		3.6	V
ldr	Data Retention Current	$\label{eq:VDD} \begin{array}{l} V_{DD} = 2.0V, \ \overline{CE} \geq V_{DD} - 0.2V \\ V_{IN} \geq V_{DD} - 0.2V, \ \text{or} \ V_{IN} \leq V_{SS} + 0.2V \end{array}$	Com. Ind. Auto. typ. ⁽¹⁾		 2	15 20 50	μA
tsdr	Data Retention Setup Time	See Data Retention Waveform		0		_	ns
t RDR	Recovery Time	See Data Retention Waveform		trc		—	ns

Note:

1. Typical Values are measured at $V_{DD} = 3.3V$, $T_A = 25^{\circ}C$ and not 100% tested.

DATA RETENTION WAVEFORM (CE Controlled)





ORDERING INFORMATION

Commercial Range: 0°C to +70°C

Speed (ns)	Order Part No.	Package
20	IS62LV256AL-20TL	TSOP, Lead-free
	IS62LV256AL-20JL	300-mil Plastic SOJ, Lead-free
45	IS62LV256AL-45TL	TSOP, Lead-free

Industrial Range: –40°C to +85°C

Speed (ns)	Order Part No.	Package
20	IS62LV256AL-20TLI	TSOP, Lead-free
	IS62LV256AL-20JLI	300-mil Plastic SOJ, Lead-free
45	IS62LV256AL-45TLI	TSOP, Lead-free
	IS62LV256AL-45ULI	330-mil Plastic SOP, Lead-free

Automotive Range: -40°C to +125°C

Speed (ns)	Order Part No.	Package
45	IS65LV256AL-45TLA3	TSOP, Lead-free
	IS65LV256AL-45ULA3	330-mil Plastic SOP, Lead-free



